

**SURFACE MOUNT
SCHOTTKY BARRIER RECTIFIER**

**REVERSE VOLTAGE – 100 Volts
FORWARD CURRENT – 0.15 Amperes**

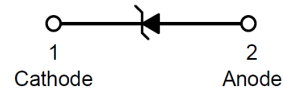
FEATURES

- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Surface mount device

MECHANICAL DATA

- Case: SOD-123 plastic
- Polarity : Cathode band
- Weight : 11.7mg (Approximately)

SOD-123



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

ABSOLUTE RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Repetitive peak reverse voltage	V_{RRM}	100	V
Continuous forward current	I_F	150	mA
Surge non repetitive forward current @ $t_p = 10ms$ Sinusoidal	I_{FSM}	1	A
Storage temperature range	T_{STG}	-55 to +150	°C
Maximum operating temperature range (Note 1)	T_J	150	°C
Maximum soldering temperature (Note 1)	T_L	260	°C

ELECTRICAL CHARACTERISTICS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Maximum reverse leakage current (Note 2)	$T_J = 25^\circ C$	I_R	$V_R = 1.5 V$	0.5	μA
			$V_R = 10 V$	0.8	
			$V_R = 50 V$	2	
			$V_R = 75 V$	5	
	$T_J = 60^\circ C$		$V_R = 1.5 V$	5	
			$V_R = 10 V$	7.5	
			$V_R = 50 V$	15	
			$V_R = 75 V$	20	
Maximum forward voltage drop (Note 1)	$T_J = 25^\circ C$	V_F	$I_F = 0.1 mA$	0.25	V
			$I_F = 10 mA$	0.45	
			$I_F = 250 mA$	1	
Typical diode capacitance	$V_R = 0 V, F = 1 MHz$	C	10	pF	
	$V_R = 1 V, F = 1 MHz$		6		

THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	VALUE	UNIT
Thermal resistance – junction to ambient (Note 3)	R_{thja}	500	°C/W

Note:

1. Pulse test: $t_p = 380 \mu s, \delta < 2 \%$
2. Pulse test: $t_p = 5 ms, \delta < 2 \%$
3. On epoxy printed circuit board with recommended pad layout

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ORDERING INFORMATION

DEVICE	MARKING	SHIPPING
BAT46W	Z46	3000/ Tape & Reel

RATING AND CHARACTERISTIC CURVES BAT46W

FIG.1 - Average forward power dissipation versus average forward current

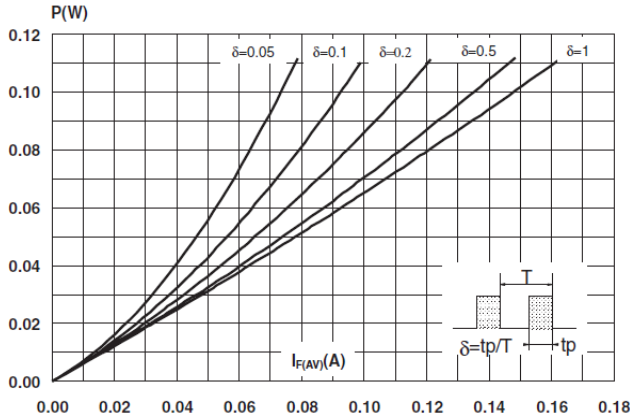


FIG. 2 - Average forward current versus ambient temperature ($\delta = 1$)

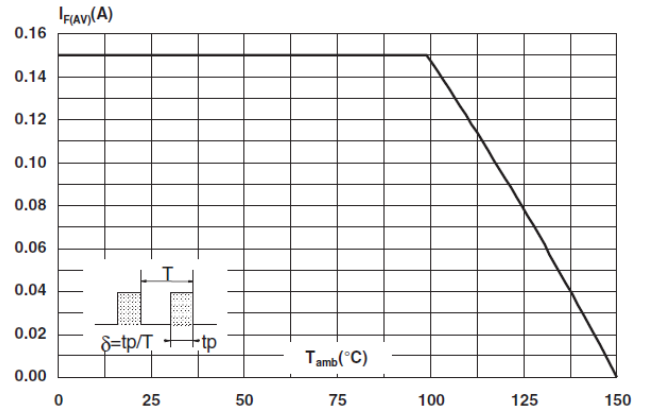


FIG.3 - Reverser leakage current versus reverse applied voltage (typical values)

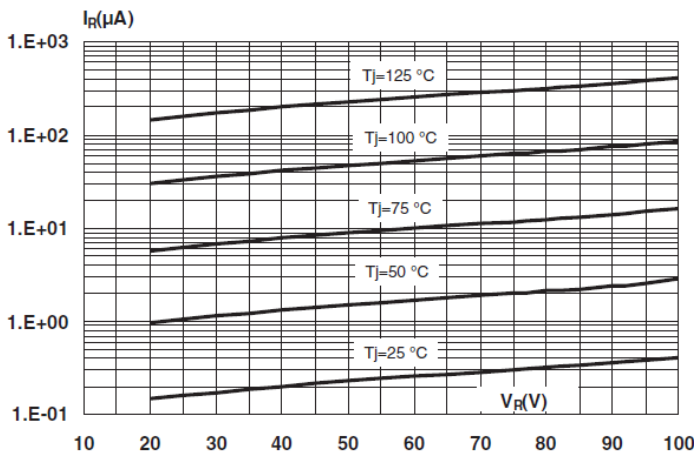


FIG.4 - Reverse leakage current versus junction temperature

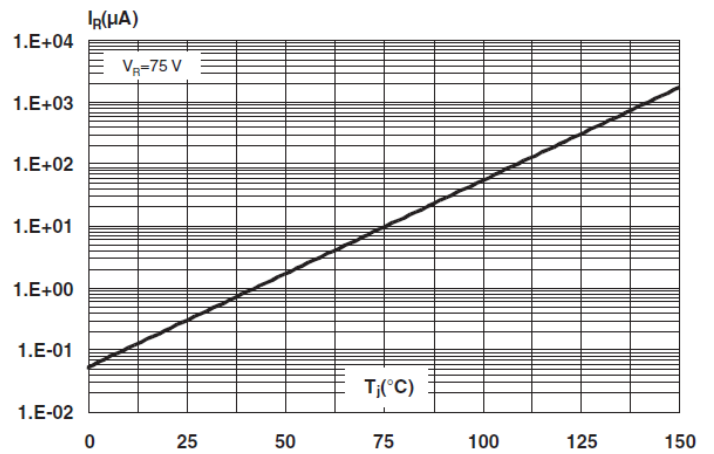


FIG.5 - Junction capacitance versus reverse applied voltage (typical values)

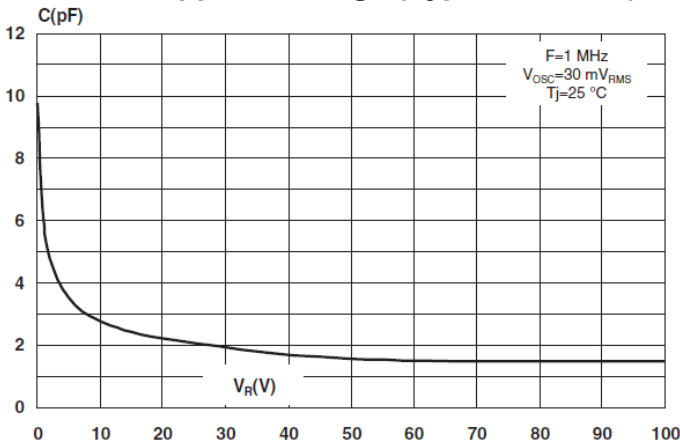
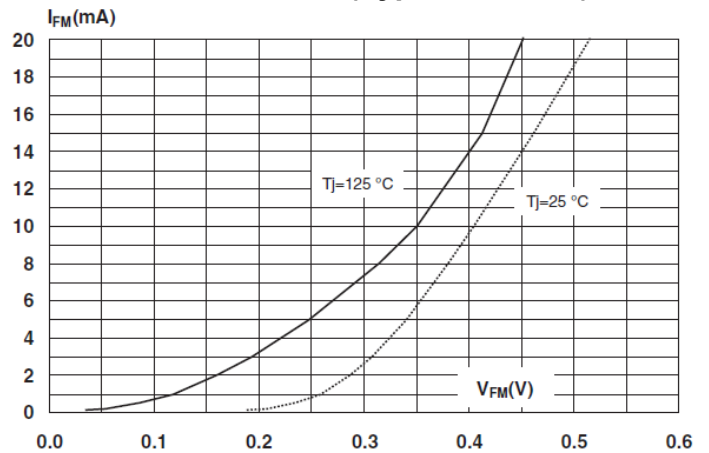
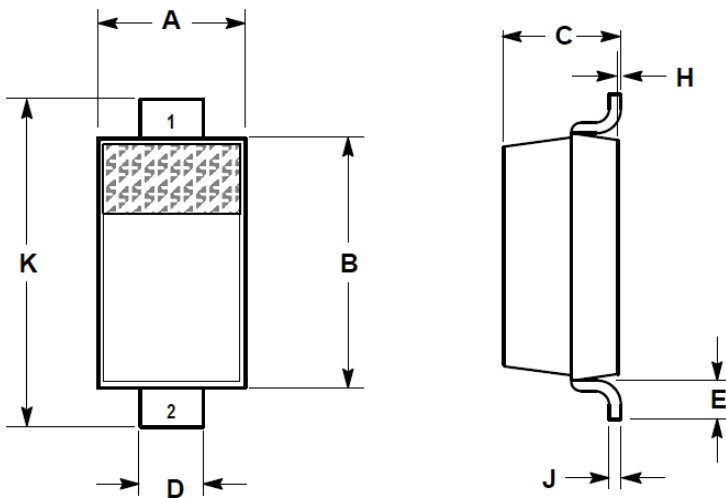


FIG.6 - Forward voltage drop versus forward current (typical values)



Package Dimensions :

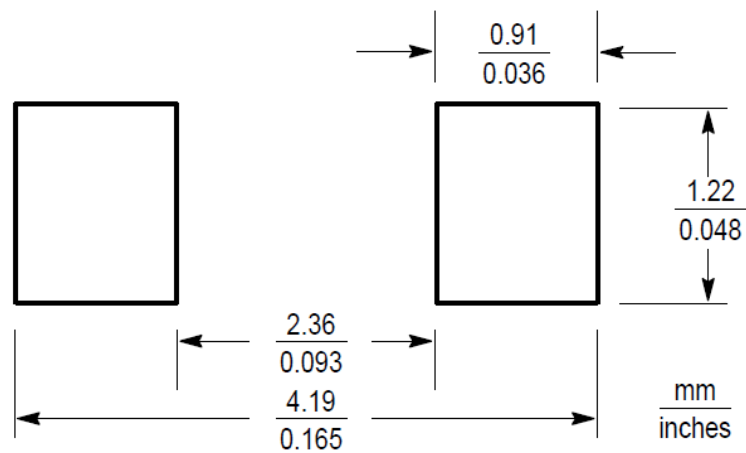
SOD-123



Dim.	INCHES		MILLIMETERS	
	Min.	Max.	Min.	Max.
A	0.055	0.071	1.40	1.80
B	0.100	0.112	2.55	2.85
C	0.037	0.053	0.95	1.35
D	0.020	0.028	0.50	0.70
G	0.004	--	0.25	--
H	0.000	0.004	0.00	0.10
J	--	0.006	--	0.15
K	0.140	0.152	3.55	3.85

Note:
PIN 1 : CATHODE
PIN 2 : ANODE

Recommended Footprint :



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